

PATENT ASSIGNMENT

SUBMISSION TYPE: NEW ASSIGNMENT

APPLICATION NUMBER
10/065609

NATURE OF CONVEYANCE: ASSIGNMENT OF ASSIGNOR'S INTEREST

CONVEYING PARTY DATA

Name: Huang, Tsung-Wei

Execution Date: 10/09/2002

Name: Chen, Chih-Ching

Execution Date: 10/09/2002

RECEIVING PARTY DATA

Name: Benq Corporation

Street Address: No.157, Shan-Ying Road
Road

Internal Address: Kweishan

City: Tao-Yuan Hsien

State:

Country: TAIWAN

Postal Code:

The USPTO, Office of Public Records, will send correspondence via facsimile to **FAX NUMBER:** +886-2-8923-7390

CORRESPONDENCE DATA:

Correspondence will be sent via US Mail when a fax number

has not been provided or the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 027765

NAME OF PERSON SIGNING: WINSTON HSU

DATE SIGNED: 11/04/2002

Total Attachments: 2

PATENT

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNORS (Inventors):

Name: Tsung-Wei Huang Nationality: R.O.C.
Address: 5F, No.22, Ta-Pei Rd., Shih-Lin, Taipei City, Taiwan, R.O.C.

Name: Chih-Ching Chen Nationality: R.O.C.
Address: 4F-5, No.145, Sec.2, Huan-Ho S. Rd., Taipei City, Taiwan, R.O.C.

Name: _____ Nationality: _____
Address: _____

Name: _____ Nationality: _____
Address: _____

Hereby sells, assigns and transfers to BENQ Corporation (hereinafter "Assignee"),
of (Assignee address) No.157, Shan-Ying Road, Kweishan, Taoyuan, Taiwan, R.O.C.
and the successors assigns and legal representatives of the ASSIGNEE the entire right, title,
and interest in and to any and all improvements which are disclosed in the invention
entitled: "FLUID INJECTION HEAD STRUCTURE AND METHOD FOR
MANUFACTURING THE SAME"

Which is found in :

- (a) _____ U.S. patent application executed on even date herewith
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this 10/09/02 (Date of signing).

(Type name of inventor)

Signature of INVENTOR

Tsung-Wei Huang

Tsung-Wei Huang

Chih-Ching Chen

Chih-Ching Chen
